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October 2008

FDS4897AC Dual N & P-Channel PowerTrench[®] MOSFET

FDS4897AC

Dual N & P-Channel PowerTrench[®] MOSFET N-Channel: 40 V, 6.1 A, 26 m Ω P-Channel: -40 V, -5.2 A, 39 m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 26 m Ω at V_{GS} = 10 V, I_D = 6.1 A
- Max $r_{DS(on)}$ = 31 m Ω at V_{GS} = 4.5 V, I_D = 5.6 A

Q2: P-Channel

- Max $r_{DS(on)}$ = 39 m Ω at V_{GS} = -10 V, I_D = -5.2 A
- Max $r_{DS(on)}$ = 65 m Ω at V_{GS} = -4.5 V, I_D = -4.1 A
- 100% UIL Tested
- RoHS Compliant

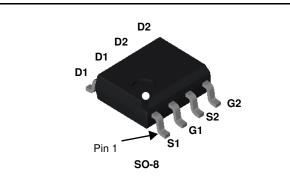


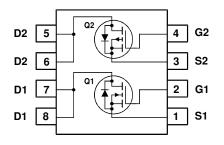
General Description

These dual N- and P-Channel MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

Applications

- Inverter
- Power Supplies





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Q1	Q2	Units
V _{DS}	Drain to Source Voltage			40	-40	V
V _{GS}	Gate to Source Voltage			±20	±20	V
1	Drain Current - Continuous			6.1	-5.2	^
D	- Pulsed				-24	A
P _D	Power Dissipation for Dual Operation			2.0		
	Power Dissipation for Single Operation	T _A = 25 °C (Note 1a) 1.6		.6	W	
		T _A = 25 °C	(Note 1b)	0	.9	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	37	73	mJ
T _J , T _{STG}	Operating and Storage Junction Temperature Range -55 to			+150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case,	(Note 1)	40	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Ambient,	(Note 1a)	78	0/11

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS4897AC	FDS4897AC	SO-8	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V \\ I_{D} = -250 \ \mu\text{A}, \ V_{GS} = 0 \ V$	Q1 Q2	40 -40			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C I_D = -250 μ A, referenced to 25 °C	Q1 Q2		37 -32		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current		Q1 Q2			1 -1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	Q1 Q2			±100 ±100	nA nA
On Chara	acteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$ $V_{GS} = V_{DS}, I_D = -250 \ \mu A$	Q1 Q2	1.5 -1.5	2.0 -2.0	3.0 -3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C I_D = -250 $\mu A,$ referenced to 25 °C	Q1 Q2		-6 6		mV/°C
(DO(LL))	Static Drain to Source On Resistance	$ \begin{array}{l} V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 6.1 \text{ A} \\ V_{GS} = 4.5 \text{ V}, \ \text{I}_{D} = 5.6 \text{ A} \\ V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 6.1 \text{ A}, \text{T}_{J} = 125 \ ^{\circ}\text{C} \end{array} $	Q1		20 24 30	26 31 39	mΩ
r _{DS(on)}		$ \begin{array}{l} V_{GS} = -10 \ V, \ I_D = -5.2 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -4.1 \ A \\ V_{GS} = -10 \ V, \ I_D = -5.2 \ A, \ T_J = 125 \ ^\circ C \end{array} $	Q2		28 45 41	39 65 57	11122
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V$, $I_D = 6.1 A$ $V_{DD} = -5 V$, $I_D = -5.2 A$	Q1 Q2		24 14		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	Q1 V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2		795 765	1055 1015	pF
C _{oss}	Output Capacitance	Q2	Q1 Q2		95 135	130 180	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = -20 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2		65 80	100 120	pF
R _g	Gate Resistance		Q1 Q2		1.7 3.6		Ω
Switchin	g Characteristics						
t _{d(on)}	Turn-On Delay Time		Q1 Q2		6 8	12 15	ns
t _r	Rise Time	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 6.1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	Q1 Q2		2 3	10 10	ns
t _{d(off)}	Turn-Off Delay Time	Q2 V _{DD} = -20 V, I _D = -5.2 A,	Q1 Q2		17 17	30 30	ns
t _f	Fall Time	$V_{\rm GS}$ = -10 V, $R_{\rm GEN}$ = 6 Ω	Q1 Q2		2 3	10 10	ns
Q _{g(TOT)}	Total Gate Charge	Q1	Q1 Q2		15 15	21 20	nC
Q _{gs}	Gate to Source Charge	V _{GS} = 10 V, V _{DD} = 20 V, I _D = 6.1 A -Q2	Q1 Q2		2.5 2.6		nC
Q _{gd}	Gate to Drain "Miller" Charge	$V_{GS} = -10 \text{ V}, V_{DD} = -20 \text{ V}, I_D = -5.2 \text{ A}$	Q1 Q2		2.9 3.2		nC

2

Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units
Drain-S	ource Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = 1.3 A$ $V_{GS} = 0 V$, $I_{S} = -1.3 A$	(Note 2) (Note 2)	Q1 Q2		0.75 -0.76	1.2 -1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 6.1 A, di/dt = 100 A/s		Q1 Q2		17 20	31 36	ns
Q _{rr}	Reverse Recovery Charge	Q2 I _F = -5.2 A, di/dt = 100 A/s	-	Q1 Q2		7 10	15 20	nC

Notes:
I: R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



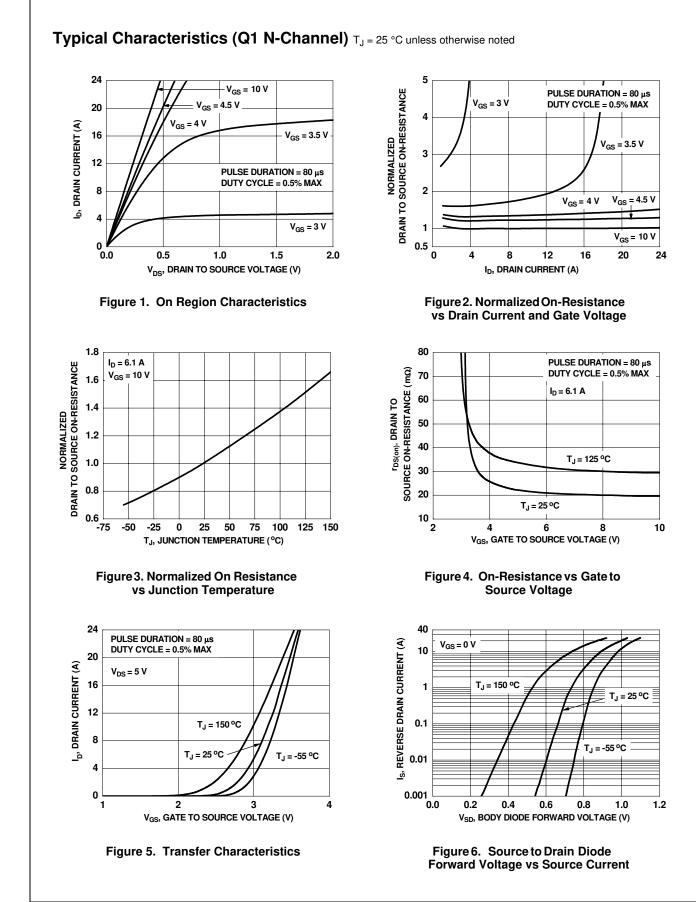
a) 78 °C/W when mounted on a 1 in² pad of 2 oz copper



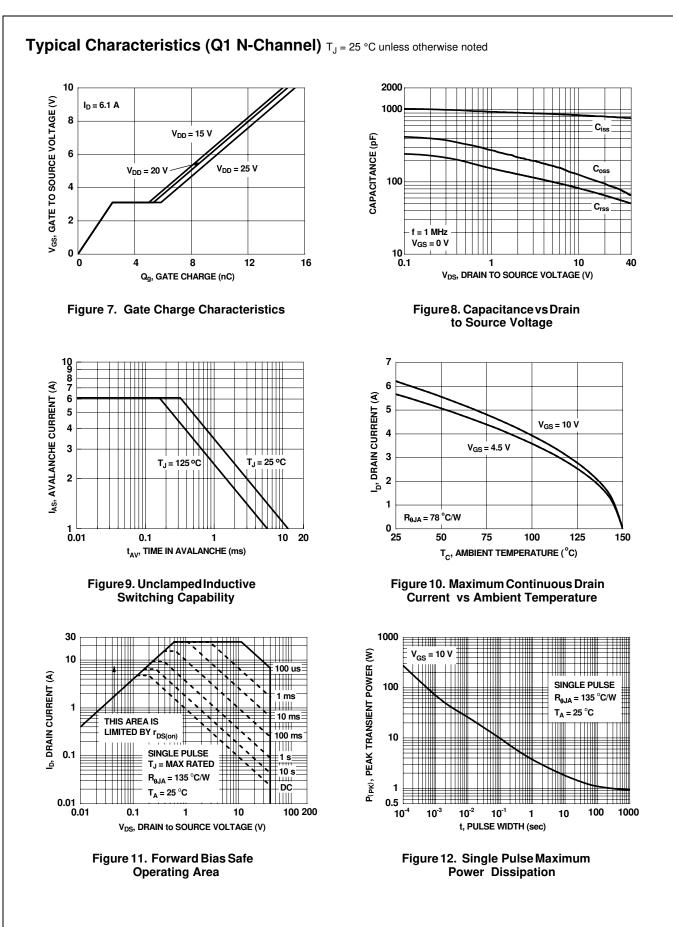
b) 135 °C/W when mounted on a minimun pad

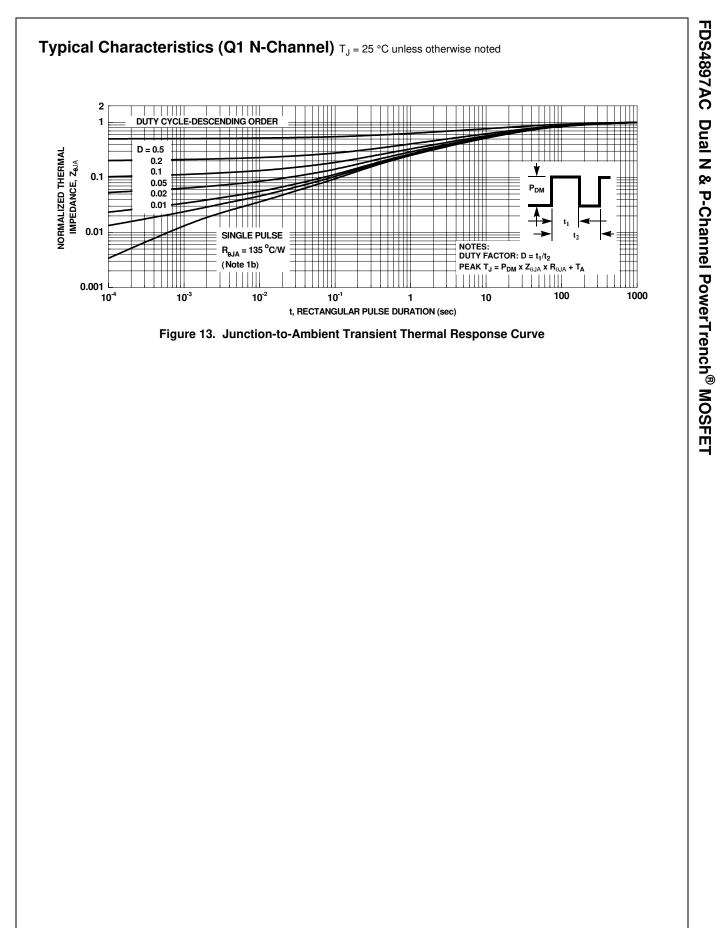
2: Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3: Starting T_J = 25 °C, N-ch: L = 3 mH, I_{AS} = 5 A, V_{DD} = 40 V, V_{GS} = 10 V; P-ch: L = 3 mH, I_{AS} = -7 A, V_{DD} = -40 V, V_{GS} = -10 V.

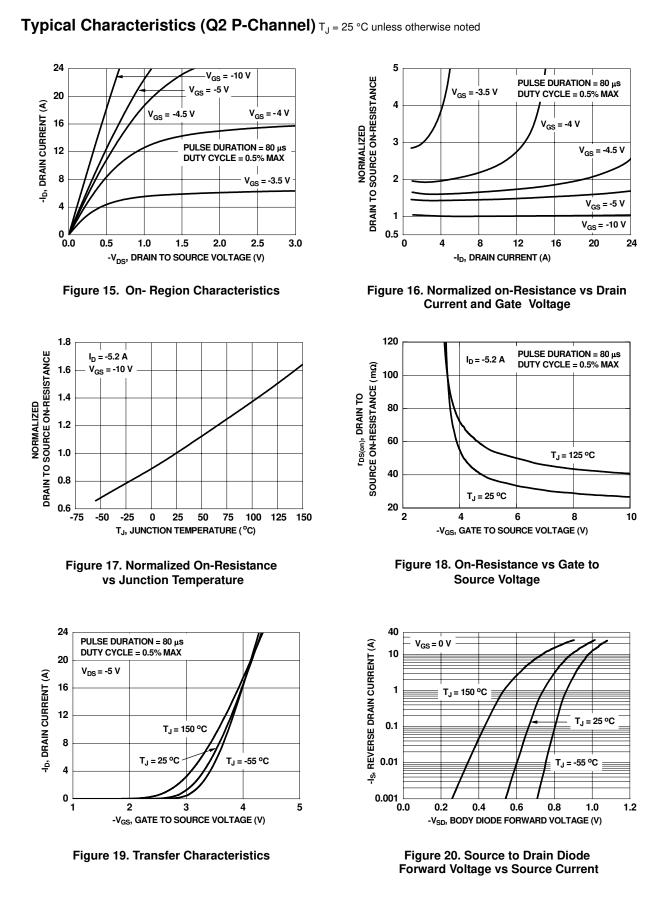
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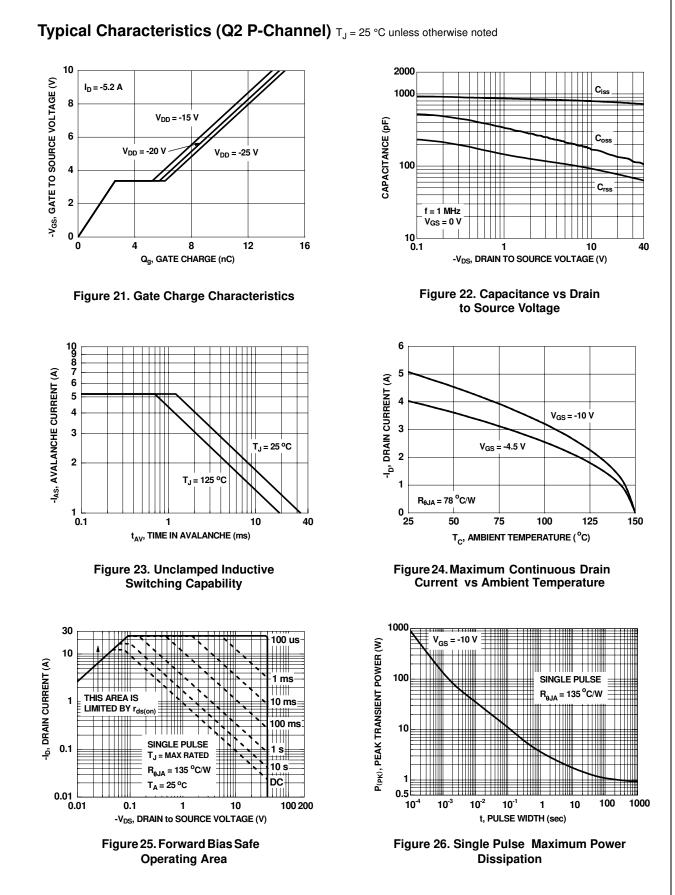


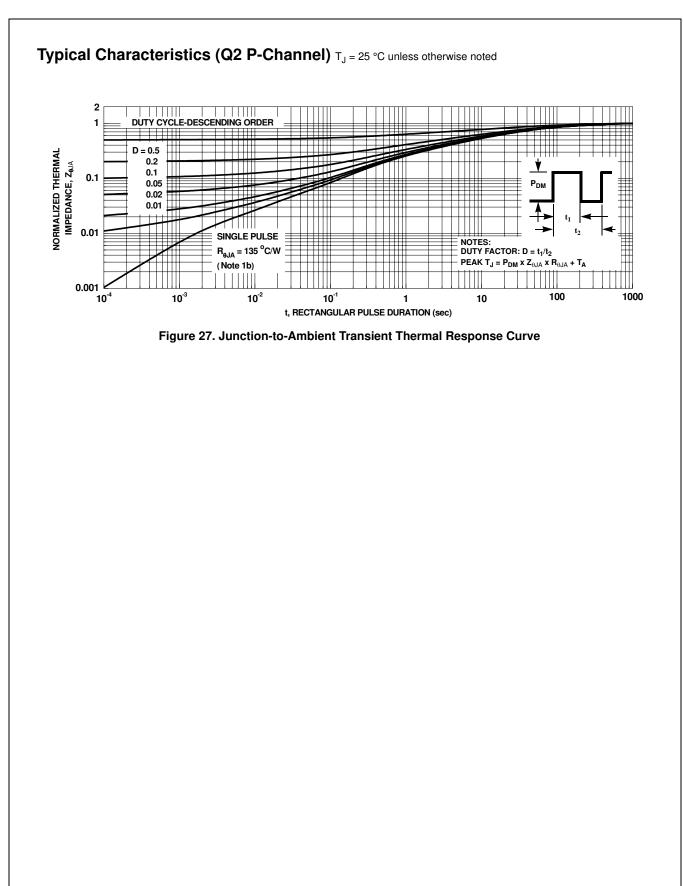


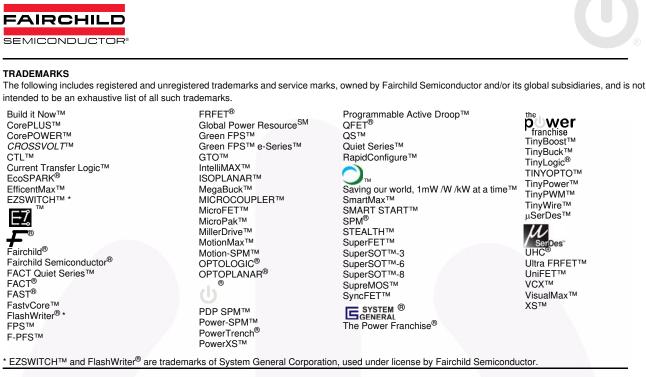




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